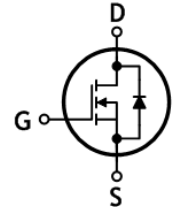
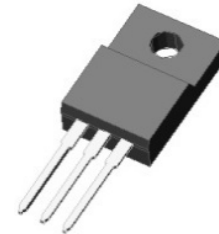


## HIGH SPEED SWITCHING APPLICATION

### Features

- Low drain-source On resistance:  $R_{DS(on)}=1.05\Omega$  (Typ.)
- Low gate charge:  $Q_g=21nC$  (Typ.)
- Low reverse transfer capacitance:  $C_{rss}=5pF$  (Typ.)
- Lower EMI noise
- RoHS compliant device
- 100% avalanche tested



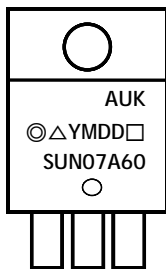
G D S

TO-220F-3L

### Ordering Information

Part Number	Marking	Package
SUN07A60F	SUN07A60	TO-220F-3L

### Marking Information



Column 1: Manufacturer  
 Column 2: Production Information

e.g.) ◎△YMDD□

- . ◎: Option Code
- . △: Factory Management Code
- . YMDD: Date Code (Year, Month, Daily)
- . □: Package Option Code

Column 3: Device Code

### Absolute maximum ratings ( $T_C=25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Rating	Unit	
Drain-source voltage	$V_{DSS}$	600	V	
Gate-source voltage	$V_{GSS}$	±30	V	
Drain current (DC) *	$I_D$	$T_C=25^\circ\text{C}$	7	A
		$T_C=100^\circ\text{C}$	4.43	A
Drain current (Pulsed) *	$I_{DM}$	28	A	
Single avalanche energy <sup>(Note 2)</sup>	$E_{AS}$	93.5	mJ	
Repetitive avalanche current <sup>(Note 1)</sup>	$I_{AR}$	7	A	
Repetitive avalanche energy <sup>(Note 1)</sup>	$E_{AR}$	3.2	mJ	
Power dissipation	$P_D$	32	W	
Junction temperature	$T_J$	150	°C	
Storage temperature range	$T_{stg}$	-55-150	°C	

\* Limited only maximum junction temperature

## Thermal Characteristics

Characteristic	Symbol	Rating	Unit
Thermal resistance, junction to case	$R_{th(j-c)}$	Max. 3.9	°C/W
Thermal resistance, junction to ambient	$R_{th(j-a)}$	Max. 62.5	

## Electrical Characteristics ( $T_C=25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Drain-source breakdown voltage	$BV_{DSS}$	$I_D=250\mu\text{A}$ , $V_{GS}=0$	600	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$I_D=250\mu\text{A}$ , $V_{DS}=V_{GS}$	3	-	5	V
Drain-source cut-off current	$I_{DSS}$	$V_{DS}=600\text{V}$ , $V_{GS}=0\text{V}$	-	-	1	$\mu\text{A}$
		$V_{DS}=600\text{V}$ , $T_C=150^\circ\text{C}$	-	-	100	$\mu\text{A}$
Gate leakage current	$I_{GSS}$	$V_{DS}=0\text{V}$ , $V_{GS}=\pm 30\text{V}$	-	-	$\pm 100$	nA
Drain-source on-resistance	$R_{DS(ON)}$	$V_{GS}=10\text{V}$ , $I_D=3.5\text{A}$	-	1.05	1.2	$\Omega$
Forward transfer conductance (Note 3)	$g_{fs}$	$V_{DS}=10\text{V}$ , $I_D=3.5\text{A}$	-	7.8	-	S
Input capacitance	$C_{iss}$	$V_{DS}=25\text{V}$ , $V_{GS}=0\text{V}$ , $f=1.0\text{MHz}$	-	1350	-	pF
Output capacitance	$C_{oss}$		-	93	-	
Reverse transfer capacitance	$C_{rss}$		-	5	-	
Turn-on delay time (Note 3,4)	$t_{d(on)}$	$V_{DS}=300\text{V}$ , $I_D=7\text{A}$ , $R_G=25\Omega$	-	68	-	ns
Rise time (Note 3,4)	$t_r$		-	38	-	
Turn-off delay time (Note 3,4)	$t_{d(off)}$		-	129	-	
Fall time (Note 3,4)	$t_f$		-	24	-	
Total gate charge (Note 3,4)	$Q_g$	$V_{DS}=480\text{V}$ , $V_{GS}=10\text{V}$ , $I_D=7\text{A}$	-	21	27	nC
Gate-source charge (Note 3,4)	$Q_{gs}$		-	9	-	
Gate-drain charge (Note 3,4)	$Q_{gd}$		-	5	-	

## Source-Drain Diode Ratings and Characteristics ( $T_C=25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Source current (DC)	$I_S$	Integral reverse diode in the MOSFET	-	-	7	A
Source current (Pulsed)	$I_{SM}$		-	-	28	A
Forward voltage	$V_{SD}$	$V_{GS}=0\text{V}$ , $I_{SD}=7\text{A}$	-	-	1.4	V
Reverse recovery time (Note 3,4)	$t_{rr}$	$I_{SD}=7\text{A}$ , $V_{GS}=0\text{V}$ $di_F/dt=100\text{A}/\mu\text{s}$	-	386	-	ns
Reverse recovery charge (Note 3,4)	$Q_{rr}$		-	1.6	-	$\mu\text{C}$

Note:

1. Repeated rating: Pulse width limited by safe operating area
2.  $L=3.5\text{mH}$ ,  $I_{AS}=7\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
3. Pulse test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$
4. Essentially independent of operating temperature typical characteristics

## Typical Electrical Characteristics Curves

Fig. 1 Typical Output Characteristics

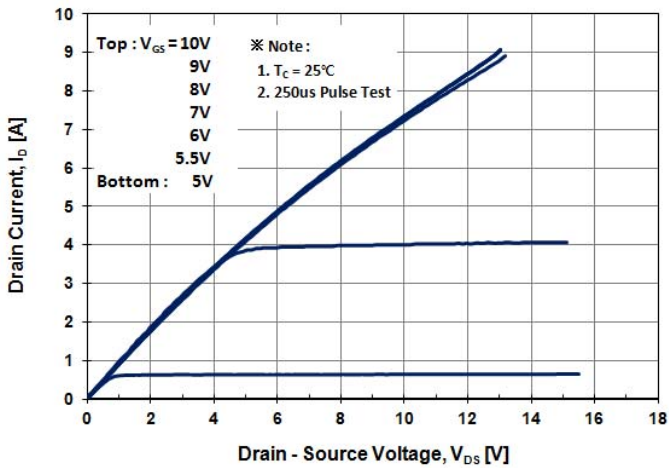


Fig. 2 Typical Output Characteristics

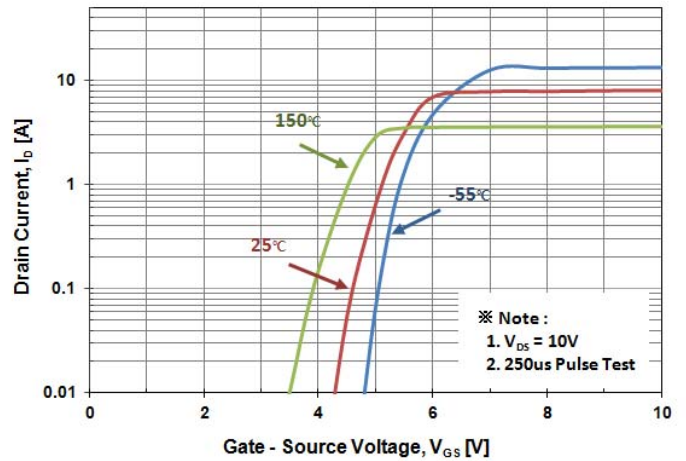


Fig.3 On-Resistance Variation with Drain Current and Gate Voltage

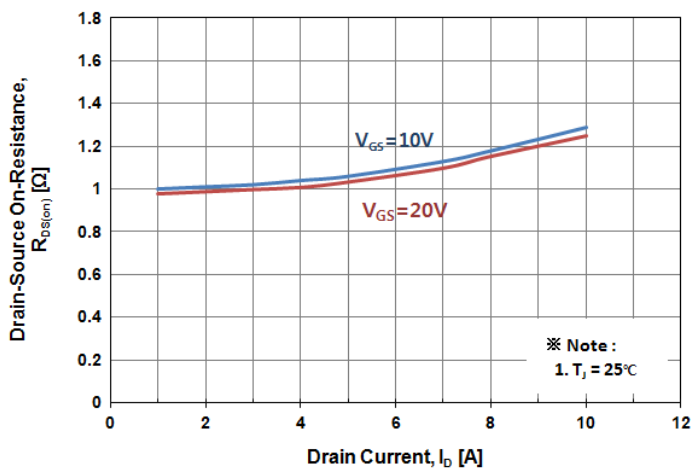


Fig. 4 Body Diode Forward Voltage Variation with Source Current

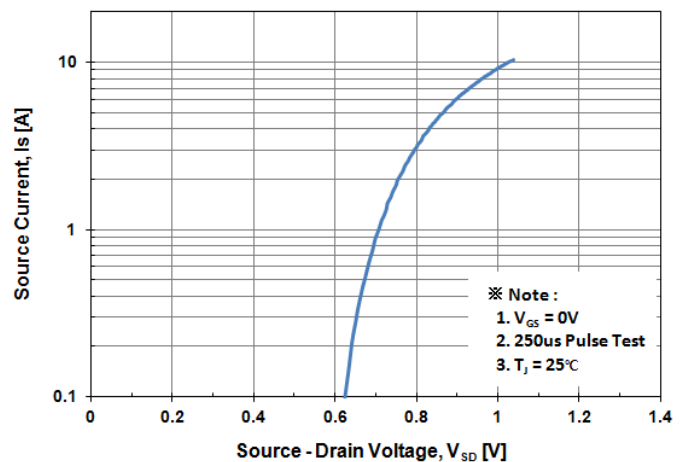


Fig. 5 Typical Capacitance Characteristics

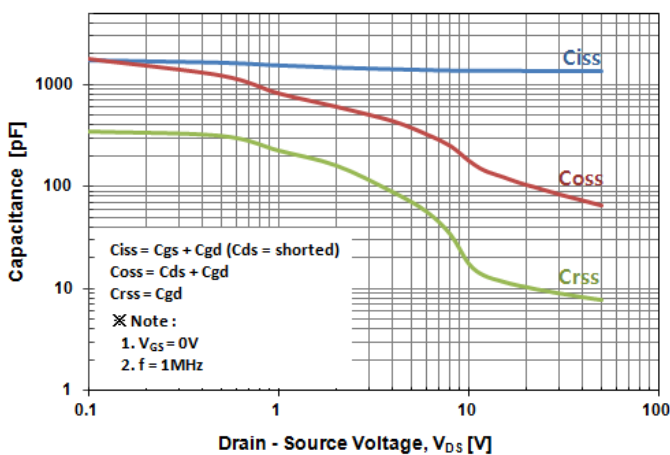


Fig. 6 Typical Total Gate Charge Characteristics

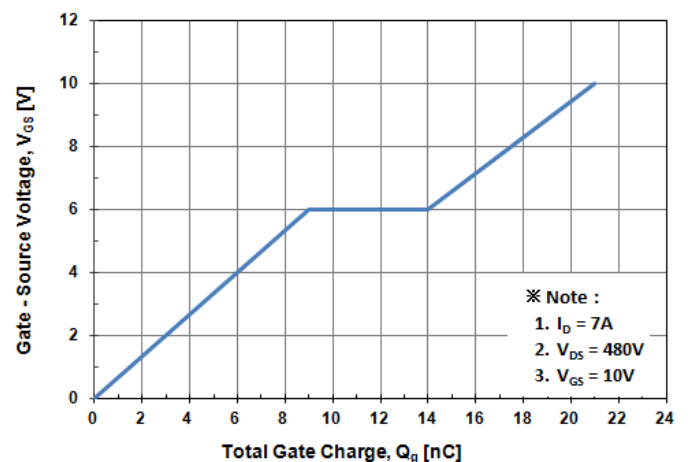


Fig. 7 Breakdown Voltage Variation vs. Temperature

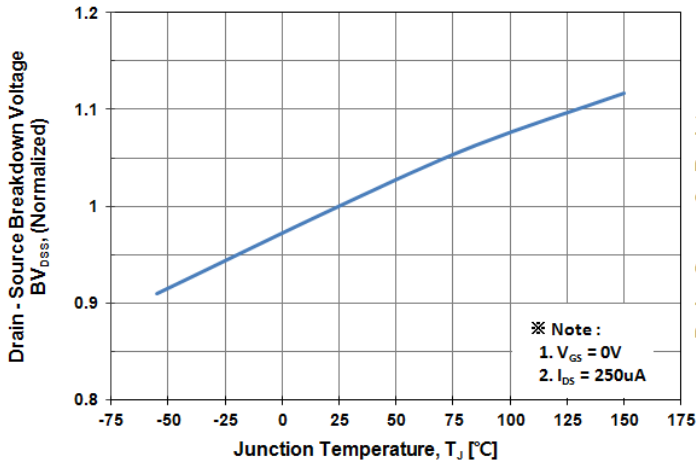


Fig. 8 On-Resistance Variation vs. Temperature

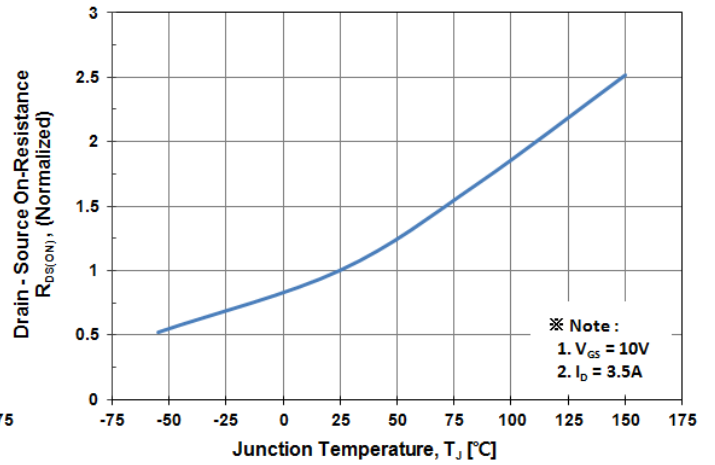


Fig. 9 Maximum Drain Current vs. Case Temperature

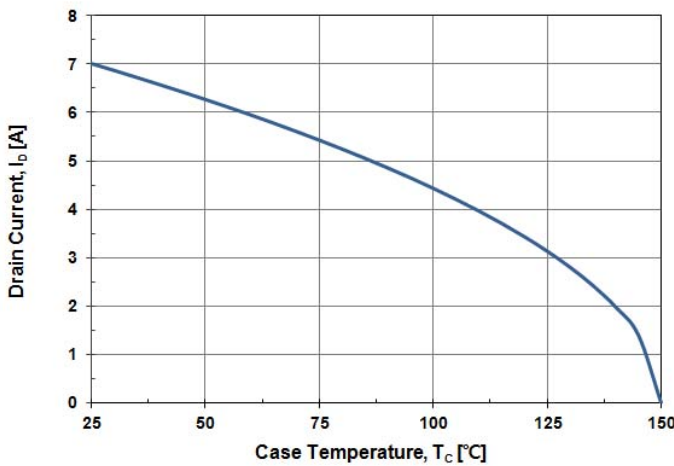


Fig. 10 Maximum Safe Operating Area

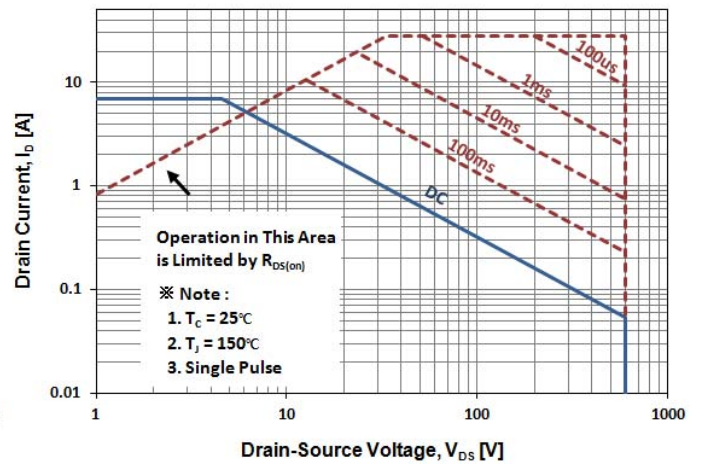


Fig. 11 Transient Thermal Impedance

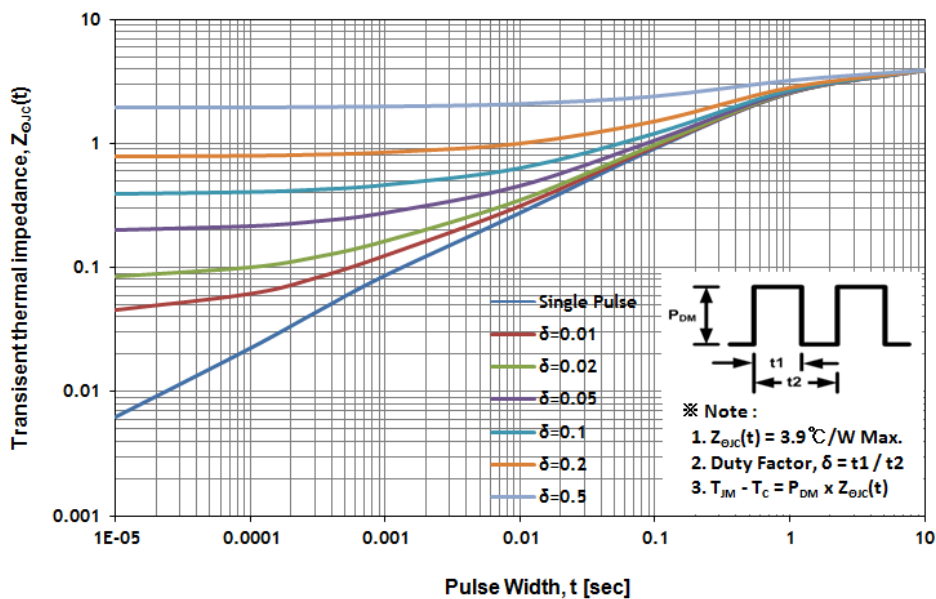


Fig. 12 Gate Charge Test Circuit & Waveform

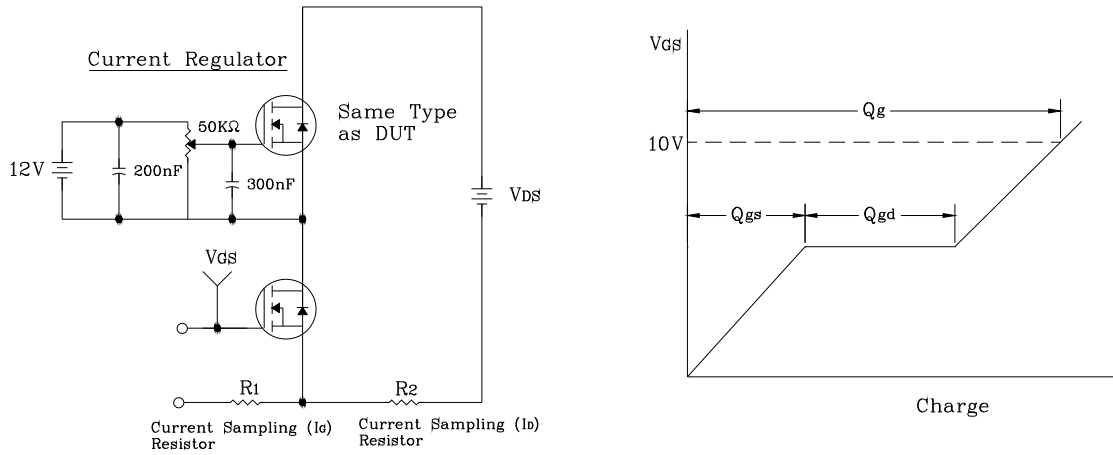


Fig. 13 Resistive Switching Test Circuit & Waveform

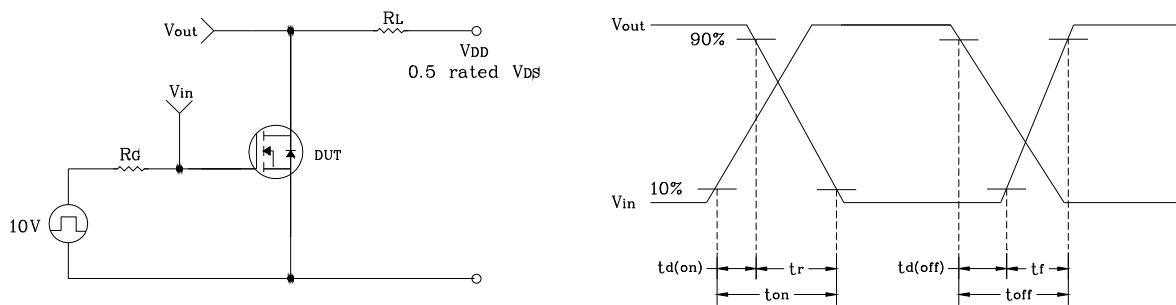


Fig. 14  $E_{AS}$  Test Circuit & Waveform

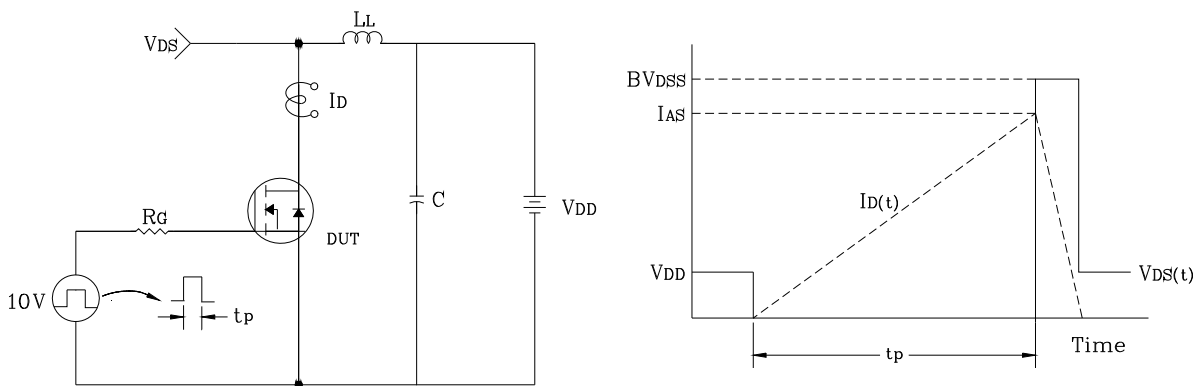
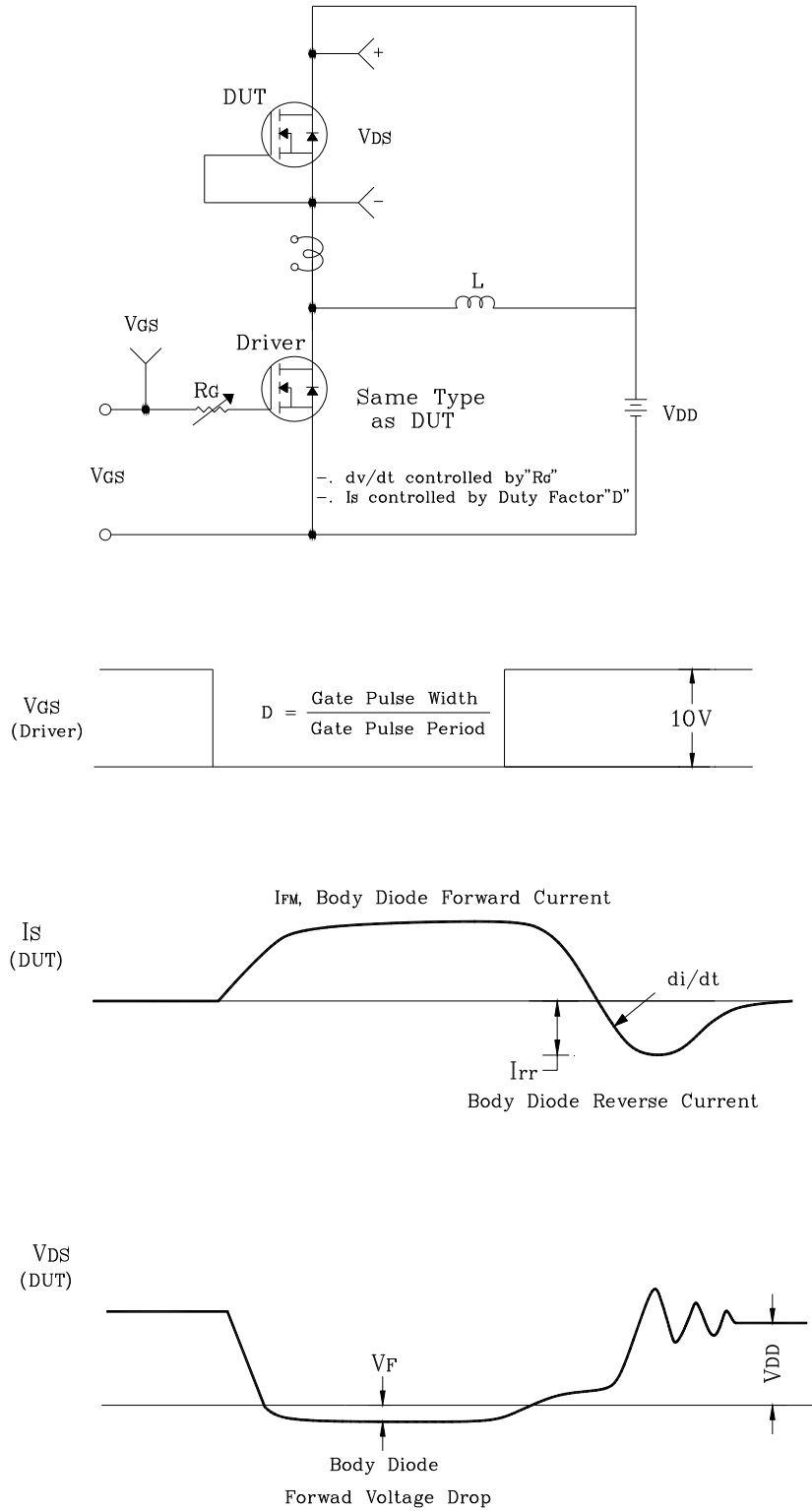
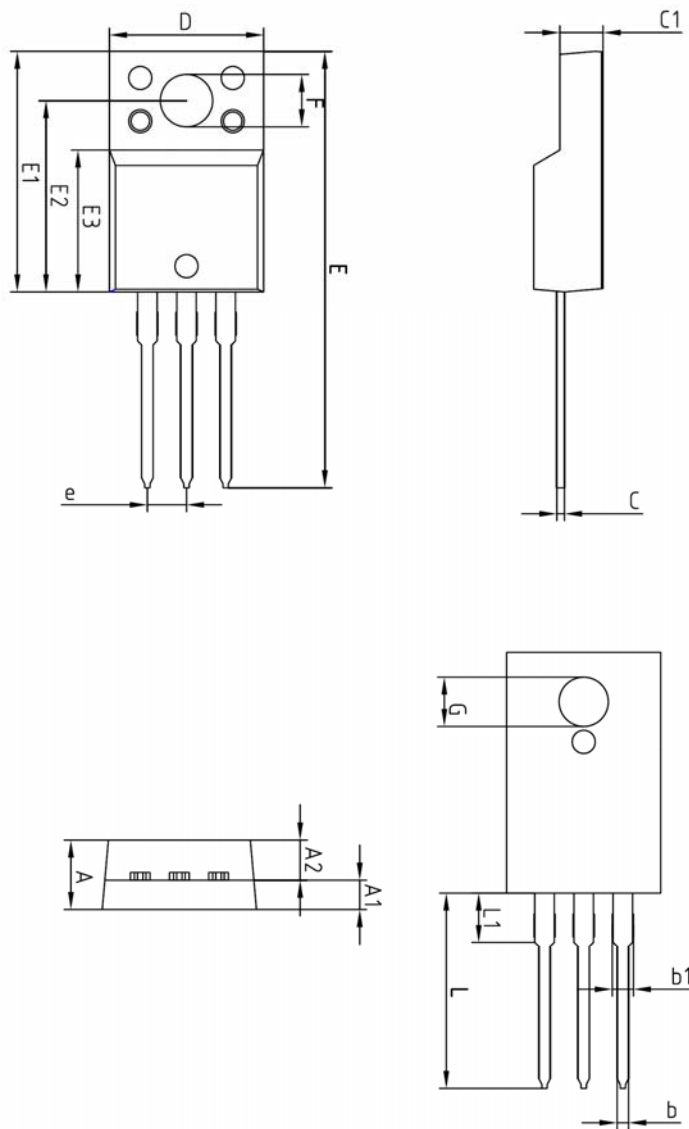


Fig. 15 Diode Reverse Recovery Time Test Circuit & Waveform



Package Outline Dimensions



SYMBOL	MILLIMETERS			NOTE
	MINIMUM	NOMINAL	MAXIMUM	
A	-	-	4.60	
A1	2.45	2.50	2.55	
A2	1.95	2.00	2.05	
b	0.65	0.75	0.85	
b1	1.07	1.27	1.47	
C	0.40	0.50	0.60	
C1	2.70	2.80	2.90	
D	9.90	10.00	10.10	
E	28.00	-	28.60	
E1	15.50	15.60	15.70	
E2	12.30	12.40	12.50	
E3	9.15	9.20	9.25	
F	3.30	3.40	3.50	
G	3.10	3.20	3.30	
e	2.54 BSC			
L	12.40	-	13.00	
L1	3.46 BSC			

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